

dE/dx analysis of TPC detector prototype and new ASIC chip commissioning

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Overview

- 1 TPC detector with UV laser
- 2 New electronic testing for TPC
- 3 Contributions for Snowmass and Summary

- dE/dx resolution of TPC detector with UV laser

Motivation- Particle identification

$$\sigma_{dE/dx} = \sigma_0 N_{hits}^{-k}$$

| Experiment | Readout | Points | Sample | $p(\text{GeV}/c)$ | $(\sigma_I/I)_{MC}$ | $(\sigma_I/I)_{exp}$ |
|--------------------------------------|-------------------|----------|--------|-------------------|---------------------|----------------------|
| | Pad (mm) | | | | | |
| PEP-4 TPC | 4 | 183 | e | 14.5 | 2.6% | 3.5% |
| TOPAZ TPC | 4 | 175 | π | 0.4-0.6 | 3.8% | 4.5% |
| DELPHI TPC | 4 | 192 | π | 0.4-0.6 | 5.4% | 6.2% |
| ALEPH TPC | 4 | 344 | e | 45.6 | 3.0% | 4.4% |
| STAR TPC | 12, 20 | 13,32 | π | 0.4-0.6 | 5.3% | 6.8% |
| ALICE TPC | 7.5, 10, 15 | 63,64,32 | π | 6.0 | 3.3% | 5.0% |
| TPC for CEPC | 1mm×6mm | 220 | K | 5.0 | 3.1% | |
| | Pixel (μm) | | | | | |
| GridPix TPC for ILD | 55 × 55 | 9500 | e | 2.5 | / | 4.1% |

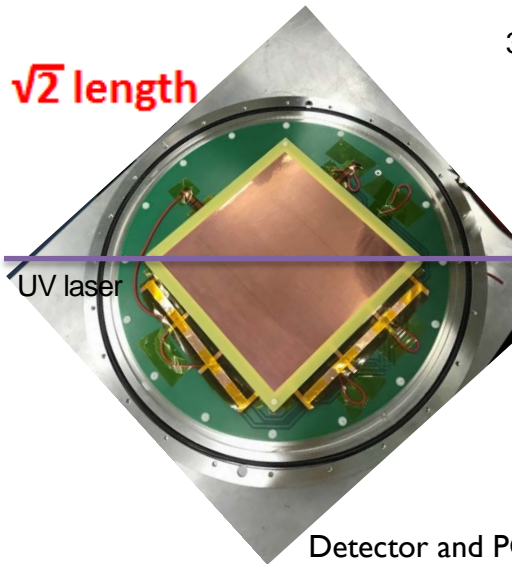
NO magnetic field
NO high energy particle testing beam



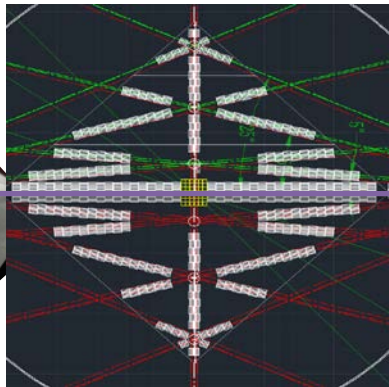
UV lasers (5 years R&D)

Pad TPC detector with UV laser

$\sqrt{2}$ length



Pad size: 1mm \times 6mm
38 hit points per track by UV laser



Detector and PCB readout board

Validation of UV laser with the mixture gases -Signal

The three operation gases for the detector compared with ILC
DESY and KEK working gas

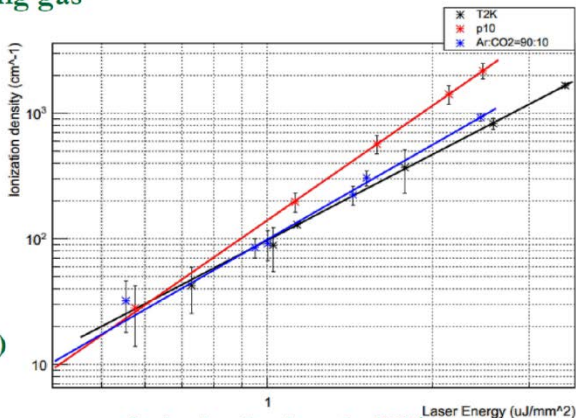
- T2K
- P10
- Ar/CO₂=90/10

Gas purity

- Ar (99.999%)
- CO₂ (99.999%)
- CH₄ (99.999%)
- CF₄ (99.999%)
- Isobutane (99.9%)

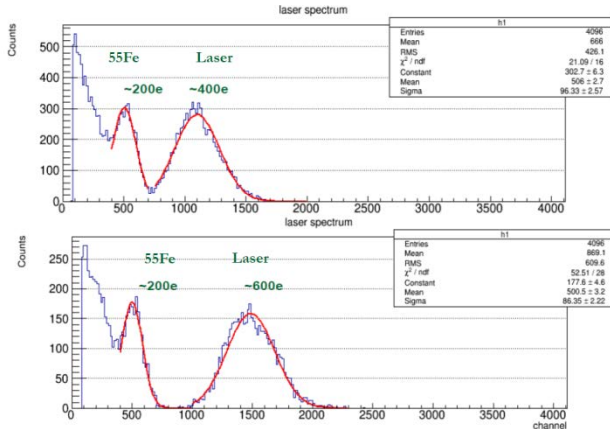
Ionization

- ~100 electrons/cm
at ~1uJ/mm²



Ionization density unit: [N]/cm
(N is the primary electron number per 0.85mm²)
Pad size: 0.9mm×6.0mm

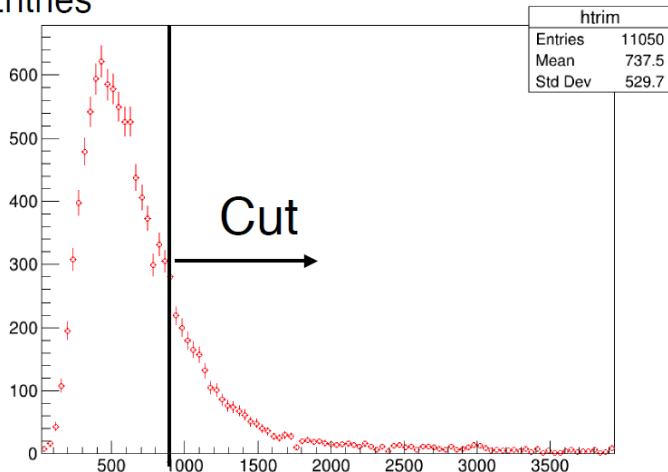
Validation of UV laser and ^{55}Fe -Energy



- Same test conditions under the same working gases and high voltage
- The ionization results indicate that the number for Ar:CO₂(90:10)-gas and T2K-gas are similar for the ionization density.
- About the gas purity, the experiment shows all mixture gas of the purity of isobutane is 99.9% despite other gases are 99.999%.

UV laser spectrum - Charge correction

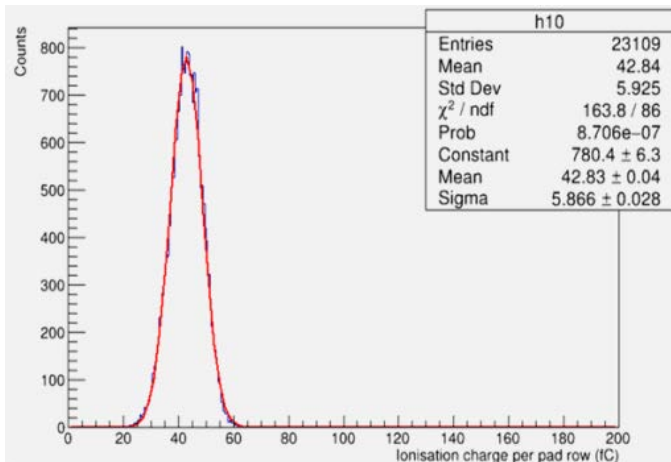
Entries



- Take 70% trim average for upper bound
- Analysis without the contribution from the tail

UV laser spectrum - Truncated method

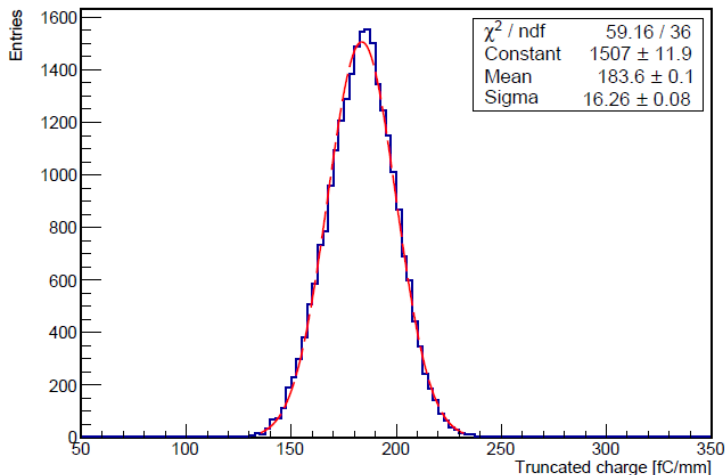
Energy cutting and correction by the events



Energy spectrum of UV

dE/dx resolution – 38 hit points

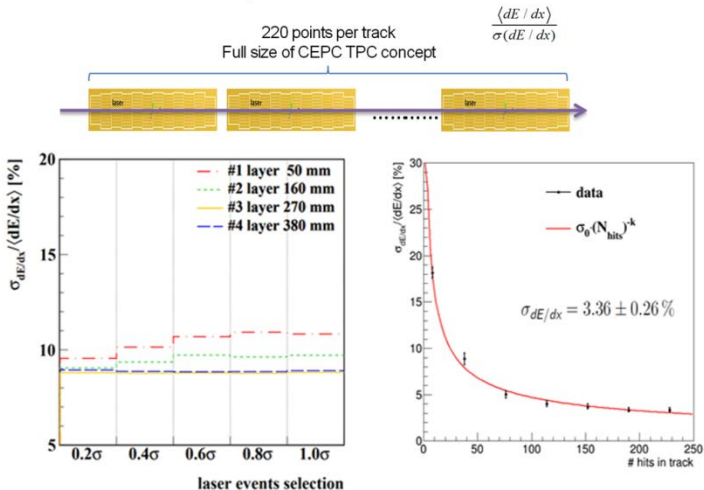
$$\sigma_{dE/dx} = (8.9 \pm 0.4) \% (38\text{hits})$$



laser events using energy cutting and correction

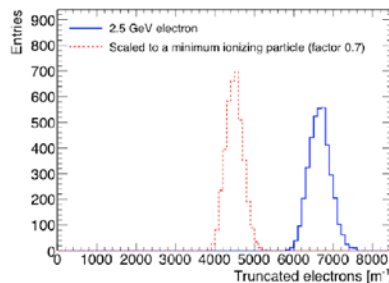
dE/dx resolution - pseudo-tracks using full size

- dE/dx resolution achieved with pseudo-tracks of various lengths
- Comparison of simulation and experimental dE/dx
- Pseudo-tracks with 220 layers and dE/dx can reach to $3.36 \pm 0.26\%$



Pixel dE/dx performance

- dE/dx resolution with truncated mean
 - From the single chip tracks; 1 m long tracks are made;
 - nr of electrons counted in slices of 20 pixel and reject 10% highest slices
 - Distances along track are scaled by 1/0.7 to get an estimation for the dE/dx of a MIP
 - Resolution is 4.1% for a 2.5 GeV electron and 4.9% for a MIP
- Separation $S = (N_e - N_{\text{MIP}})/\sigma_e$
- 8σ MIP-e separation for a 1 meter track
- A pixel readout can in principle within the resolution (diffusion) separate primary from secondary clusters. dE/dx can be measured by cluster counting and performance separation enhanced.

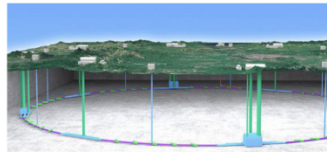


A Pixel TPC at the CEPC?

CEPC running above the Z (WW, Higgs) there are no critical issues

A Pixel TPC can deal with the high beam rates at the CEPC

- At the Z pole the CEPC with $L = 34 \cdot 10^{34} \text{ cm}^{-2} \text{ s}^{-1}$ will produce Z bosons at $\sim 10 \text{ kHz}$
- Link speed of Timepix3 (in Quad) is 80 Mbps: 2.6 MHits/s per $1.41 \times 1.41 \text{ cm}^2$
- Excellent time resolution: time stamping of tracks $< 1.2 \text{ ns}$
- Power consumption $\sim 2 \text{ W/chip}$ depends on hit rate
 - No power pulsing possible at the CEPC
 - Good cooling is important
- Ion back flow of the quad is measured to be 1.3% at a gain of ~ 2000 . So $\text{IBF} \cdot \text{Gain}$ is ~ 25 .



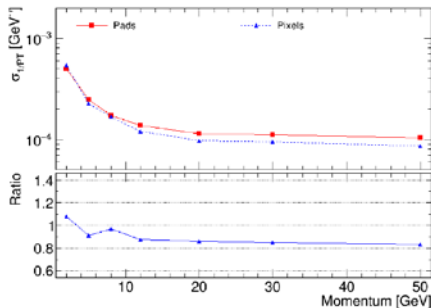
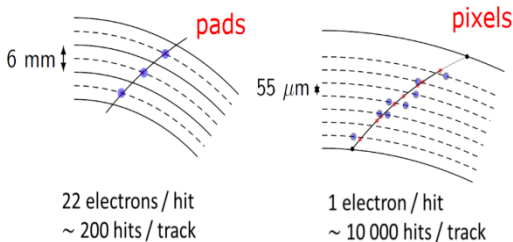
NB: to limit the distortions in de drift volume one needs to achieve < 4

LCWS 2019 Sendai talk Huirong Qi

**Collaboration: PID analysis of pixel TPC data
starting**

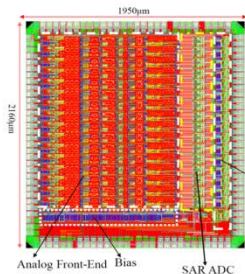
Performance of Pixel TPC at 2 Tesla

- From the full simulation the momentum resolution can be determined at 2-3 Tesla
- Momentum resolution is about **15%** better for the pixels with realistic coverage(with the quads arranged in modules 59%) compared with the pad TPC option at 3 Tesla
- Starting to check the beam data and collaborate analysis momentum resolution (preliminary showing the fine results) **/IHEP & Bonn Univ.**



- new ASIC chip commissioning

Low power ASIC chip



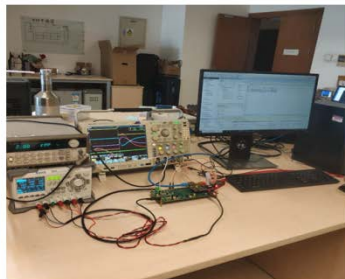
- The floor plan in layout :
 - The die size of 1950 μm x 2160 μm
 - Analog Front-End , SPI, SAR ADC, LVDS driver are supplied by separate power
- The ASIC have been taped out in November, 2019 and is being evaluated

LVDS driver

Layout of ASIC chip

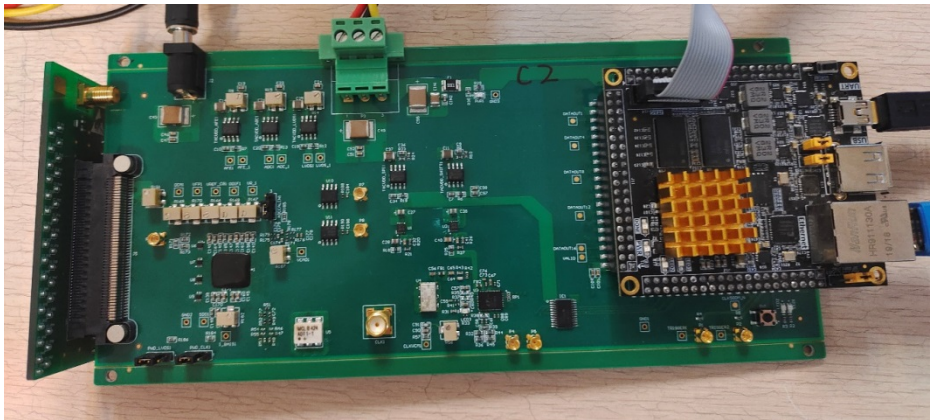
ASIC chip for TPC readout have been developed

- ❑ The power consumption is **2.33 mW/channel**
 - ❑ $P_{\text{AFE}} = 1.43 \text{ mW/channel}$
 - ❑ $P_{\text{ADC}} = 0.9 \text{ mW/channel @ } 40\text{M/s}$
- ❑ $\text{ENC} = 852e @ C_m = 2\text{pF}$, gain = 10 mV/fC and can be reduced to 474e using digital trapezoidal filter



Test of the signals

Low power ASIC chip- WASA_V0 testing board



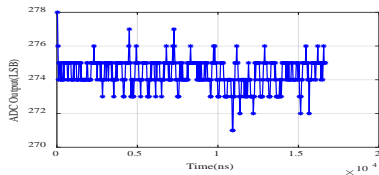
Channels: ≤ 128 channels (**only $4 \times 16 = 64$ channels available**)
External power supply: $\pm 5V$, $\pm 12V$, $\pm 24V$

Testing parameters:

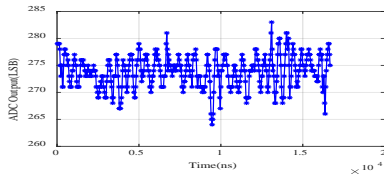
- GEMs detector: 280V-310 V
- E_{drift} : ≤ 280 V/cm
- Operation gases: Ar/CF₄/iC₄H₁₀ 95/3/2 (T2K)
- Radioactive source: ⁵⁵Fe@ 1mCi

Low power ASIC chip- Baseline of the noise

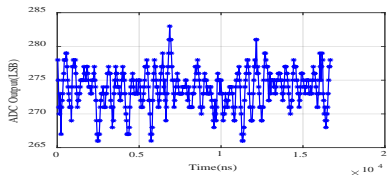
Baseline of the noise
without detector connecting



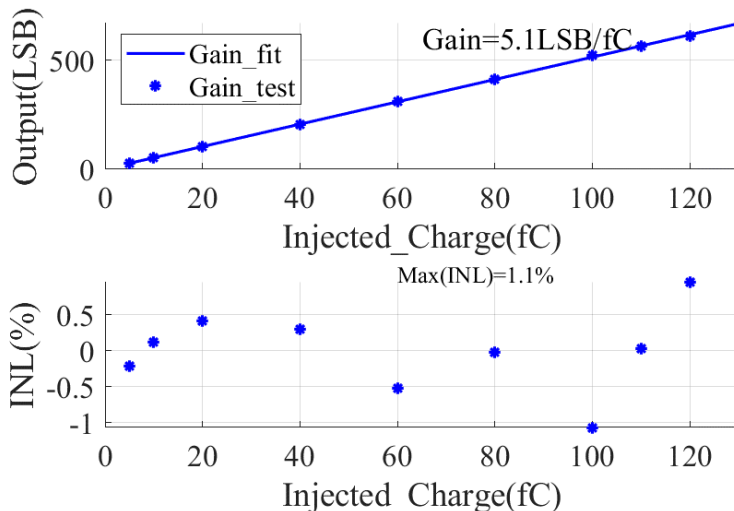
Baseline of the noise
with TPC detector connecting
@ $V_{\text{GEM}}=0\text{V}$ @ $E_{\text{drift}}=0\text{V/cm}$



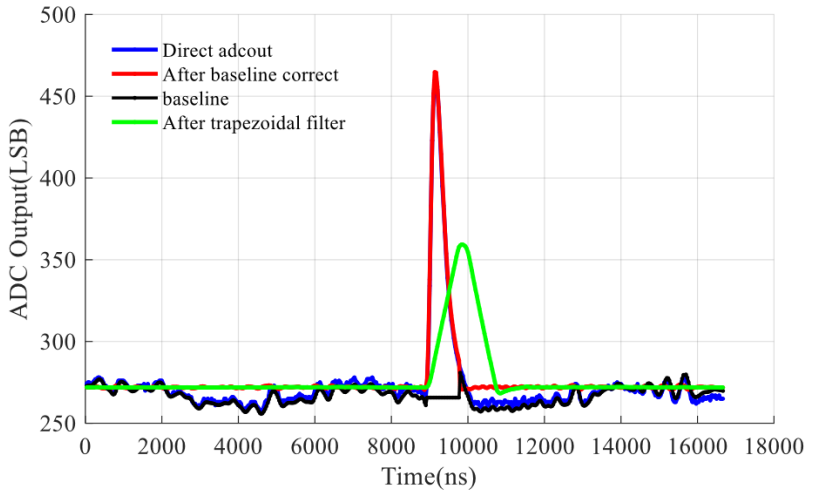
Baseline of the noise
with TPC detector connecting
@ $V_{\text{GEM}}=310\text{V}$ @ $E_{\text{drift}}=290\text{V/cm}$



Low power ASIC chip- Integral Nonlinearity



Transient Waveforms After Digital Filter

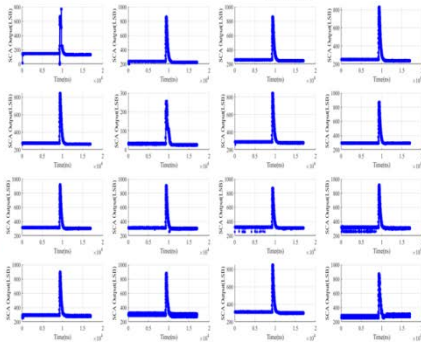
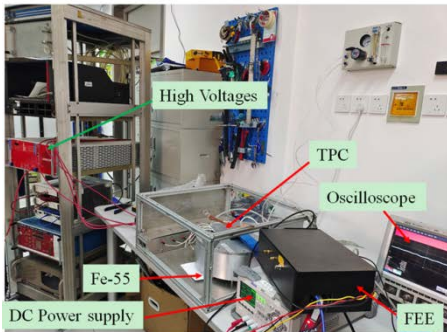
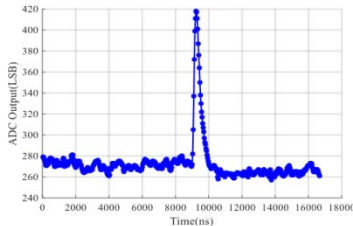


New electronics testing with the module

⁵⁵Fe testing

Testing parameters:

- GEMs detector: 280V-310 V
- E_{drift} : ≤ 280 V/cm
- Operation gases: Ar/CF₄/iC₄H₁₀ 95/3/2 (T2K)
- Radioactive source: ⁵⁵Fe @ 1mCi
- Successfully commissioned and collected signals using DAQ

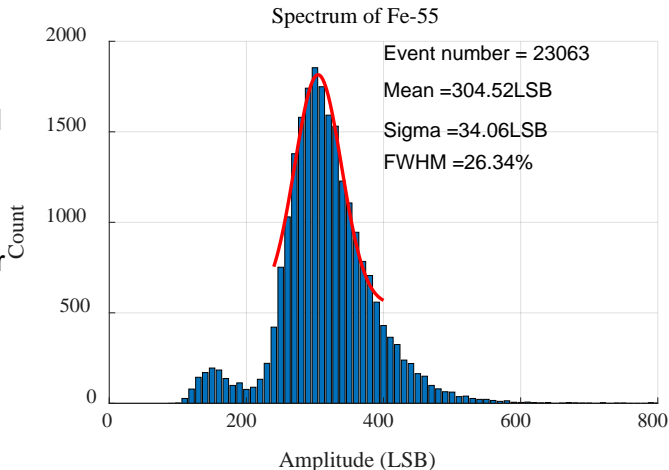


Low power ASIC chip- preliminary results

⁵⁵Fe testing:

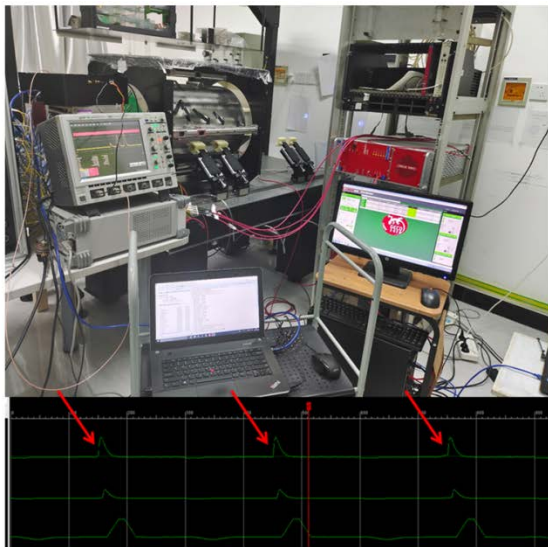
Successfully
commissioned and
collected signals
using DAQ

Using collimator for
the radioactive
source
and taking data
from 128 channels



New electronics testing with **the prototype**

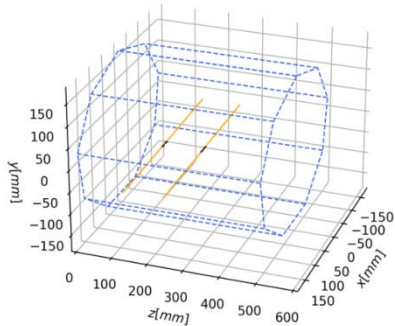
- Successfully realized the joint test of low-power ASIC chip and TPC prototype
- ASIC+TPC parameters
 - TPC:
 - GEM: 280 V
 - Drift length: 500mm
 - E drift: 180 V/cm
 - Gas: Ar/CF₄/iC₄H₁₀ 95/3/2 (T2K)
 - UV laser: 7.2 mJ @20 Hz
 - Laser tracks: 3 layers along drift length
 - Electronics:
 - Trigger by UV laser
 - Gain: 20 mV/fC
 - Sample frequency: 30 MS/s



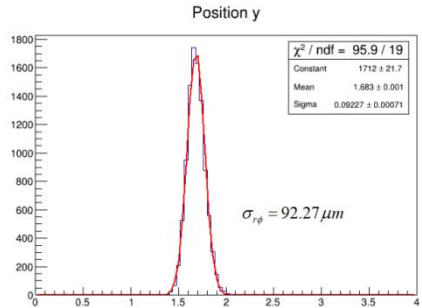
65nm ASIC + TPC prototype

Track & Position Resolution

- Laser Tracks



- Position Resolution



- Some contributions for Collaboration from IHEP 2021



**TPC Development
by the LCTPC Collaboration
for the ILD Detector at ILC**

2021 IEEE NSS/MIC Conference (Oct. 16-23):
<https://nssmic.ieee.org/2021/>
H. Qi

**2021 IEEE NSS/MIC Conference
Presentation & Proceeding**

TPCs at future lepton and lepton-hadron colliders

(large volume gaseous detectors: TPCs, drift chambers,)

ECFA

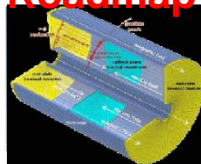
European Committee for Future Accelerators

ECFA Detector R&D Roadmap
Symposium of Task Force 1
Gaseous Detectors

ECFA Detector R&D Roadmap

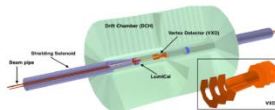
• TPCs

- MPGD amplification technology,
- Pad vs. Pixel TPC
- IBF reduction (together with other operational parameters optimisation)
- Mechanical structure, static distortions
- Low-power FEE development



• DCs

- Mechanical structure, feed-through-less wiring
- New wire materials
- PID via dN/dx (FEE development)



Summary

- dE/dx study used TPC detector using 266nm UV laser
- Pseudo-tracks with 220 layers and dE/dx can reach to $3.36 \pm 0.26\%$ of dE/dx by Pad size ($1\text{mm} \times 6\text{mm}$)
- Successfully testing and collected signals using the new electronics with the lower power consumption chips
- Some contributions for the international collaboration group from IHEP

Thanks